MICROCHIP

MX554BBF443M115

Ultra-Low Jitter 443.115234MHz LVPECL XO

ClockWorks® FUSION

General Description

The MX554BBF443M115 is an ultra-low phase jitter XO with LVPECL output optimized for high line rate applications.

Applications

- Optical communications
- Forward error correction (FEC) rates
- FPGA SERDES reference clock

Absolute Maximum Ratings¹

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T ₂)	65°C to +125°C
Storage Temperature (T _S) ESD Machine Model	200V
ESD Rating (HBM)	2kV

Features

- 443.115234MHz LVPECL
- Supports FEC line rate
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Operating Ratings²

Supply Voltage (VIN)	+2.375V to +3.63V
Ambient Temperature (TA)	40°C to +85°C
Junction Thermal Resistance	
LGA (T _{IC}) Still Air	58°C/W
JC'	

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 50 Ohms to VDD - 2V.3

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				120	mA
F0	Center Frequency			443.115234		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		85		350	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage	LVPECL output levels	VDD - 1.35	VDD - 1.01	VDD - 0.8	V
VOL	Output Low Voltage	LVPECL output levels	VDD - 2.0	VDD - 1.78	VDD - 1.6	V
Vswing	Peak to Peak Output Voltage Swing		0.65	0.77	0.95	V

Notes:

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- 3. Guaranteed after thermal equilibrium.
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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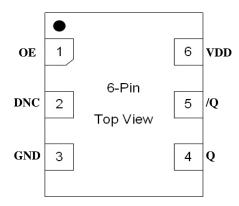
April 08, 2020 MX554BB1-8857 Revision 1.0 tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX554BBF443M115	MX554B	BF4431	Tube	6-Pin 5mm x 3.2mm LGA
MX554BBF443M115-TR	MX554B	BF4431	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



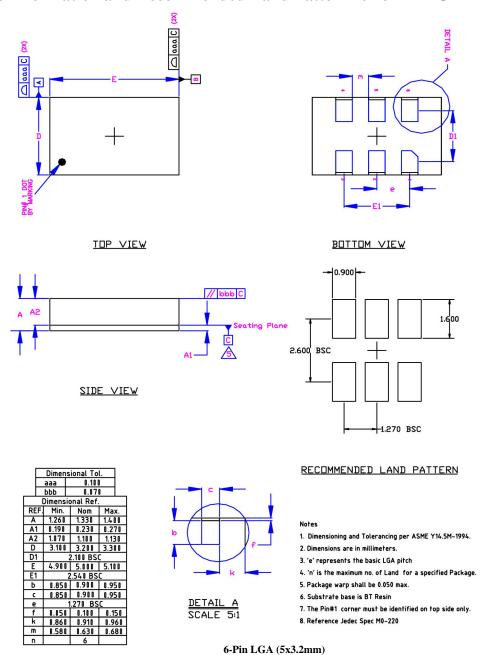
Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 1 = Disabled, 0 = Enabled, 50k Ohms Pull-Down (Internal)
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVPECL	Clock Output Frequency = 443.115234MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A	
Moisture Resistance	MIL-STD-883, Method 1004	
Mechanical Shock	MIL-STD-883, Method 2002, Condition C	
Mechanical Vibration	MIL-STD-883, Method 2007, Condition A	
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)	
Hazardous Substance	Pb-Free / RoHS / Green Compliant	
Solderability	JESD22-B102-D Method 2 (Preconditioning E)	
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D	
Gross Leak	MIL-STD-883, Method 1014, Condition C	
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s	
MSL Level	Crystal - MSL-1, Package MSL-3	
Solvent Resistance	MIL-STD-202, Method 215	

Package Information and Recommended Land Pattern for 6-Pin LGA³



Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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